




life.augmented

A photograph of a hand holding a blue butterfly in a green field. The hand is positioned at the bottom right, with the fingers gently cupping the butterfly. The butterfly is in the center, with its wings spread. The background is a soft, out-of-focus green field with some tall grasses. The overall scene is bright and natural, suggesting a connection between nature and technology.

What future for the semiconductor industry in the age of climate change?

Evolution and diversification of semiconductor technologies

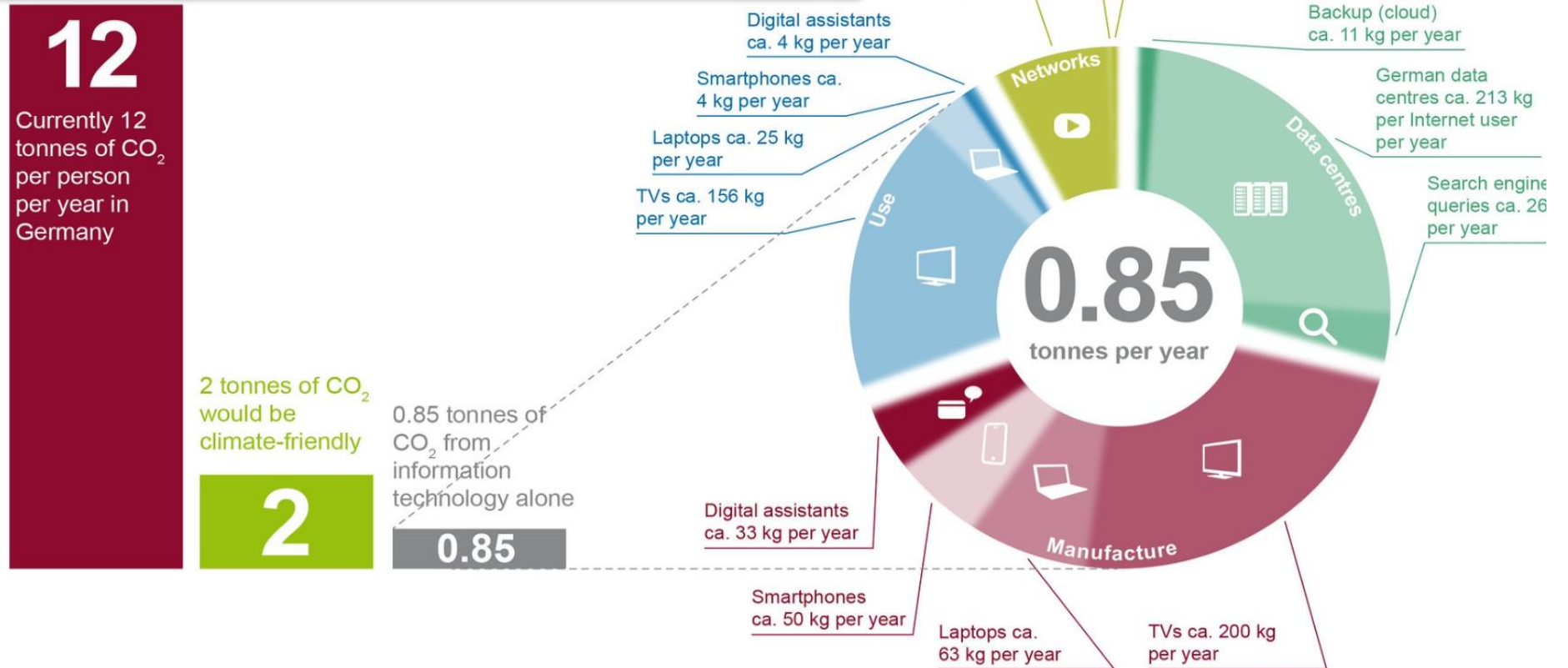
Stephane MONFRAY

Senior Principal Engineer

STMicroelectronics

CO2 emission related to numerical technologies

How can the semiconductor industry limit its impact on fabrication, and contribute to more responsible usages and applications?



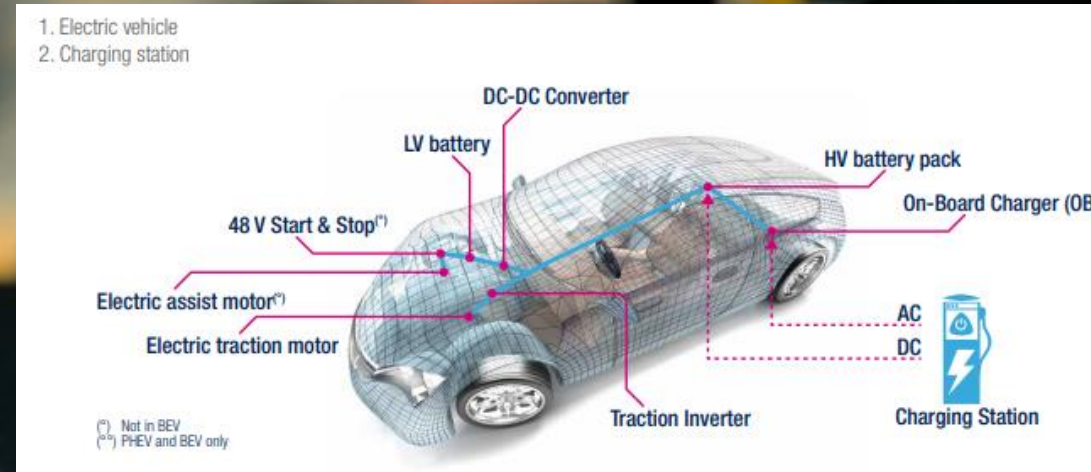
SOURCE: [HTTPS://BLOG.OEKO.DE/DIGITALER-CO2-FUSSABDRUCK](https://blog.oeko.de/digitaler-co2-fussabdruck). DIAGRAM: ÖKO-INSTITUT 2019, CC BY-SA

Examples of diversification in the semiconductor industry for responsible applications

- High impacts on end markets: **mobility, energy, connectivity**
- From ultralow power technologies to fully energy autonomous systems: **how mW can save kW**
- Examples of technologies for **environmental sensing**
- **Eco conception & sustainability**

Smart mobility: from thermal to electrical mobility

Electric vehicles sales* from ~10 million in 2021 to ~30 million in 2025



- **Electronics play a major role to deploy electric cars!**
- **Not only in a car: you need connectivity with charging station & all associated services**

>200 ST products mapped

Sources: www.asirt.org, Strategy Analytics
* Excluding Mild Hybrid EV

Power & energy

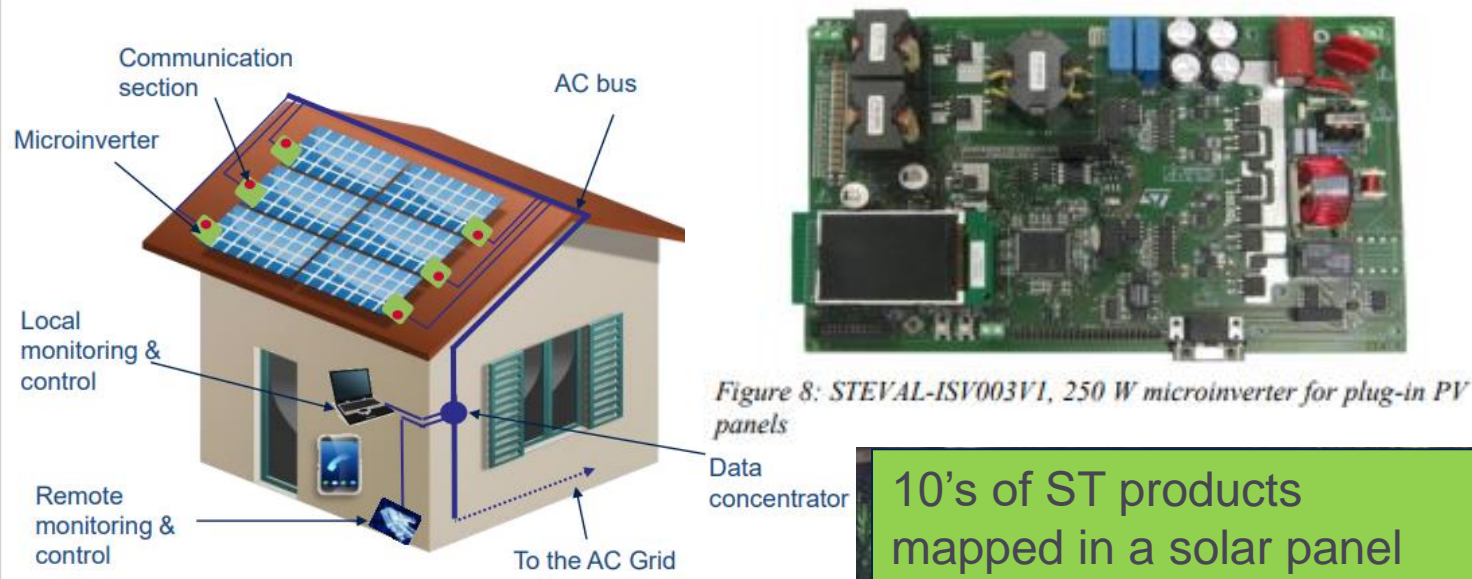
Rising demand for and usage of electrical energy

Over **30%** global electricity demand increase from 2020 to 2030

Increase use of renewable energy

Electrical energy from renewal sources from **~10%** in 2020 to **~20%** in 2030

No performant power collection without dedicated electronics!



10's of ST products mapped in a solar panel

Internet of things & connectivity

ST provides sensors, embedded processing, connectivity, security and power management, as well tools and ecosystems

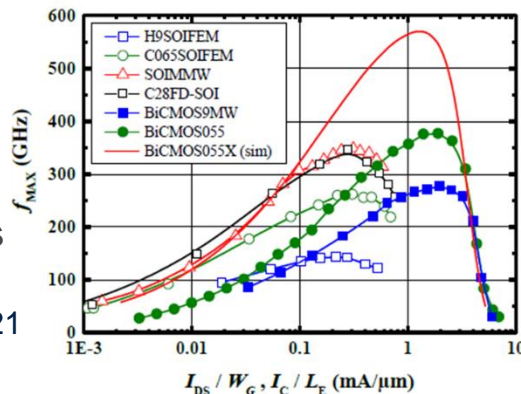


ULP MCU
STM32



Silicon
photonics
platform

Advanced &
efficient RF
technologies



P.Chevalier, SSDM21

Cloud connected and data-enabled services


More than **20 Billion** IoT connected devices per year by 2025

Digital security for all data

IoT security services market over **\$12 Billion** by 2025

Cellular accelerating the connection of objects to the IoT

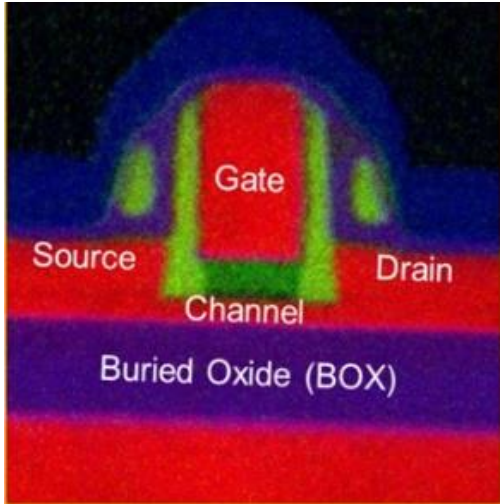
Four Billion cellular IoT connections by 2025



**Electronic devices are everywhere
and mandatory for greener mobility
and power generation**

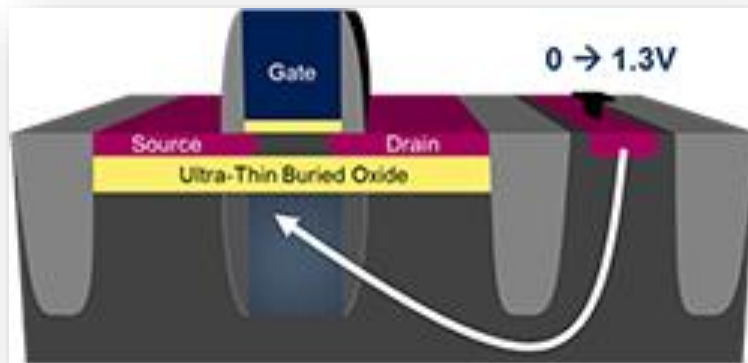
**How the technology itself can
contribute?**

Technologies for ultralow power IoT: FDSOI

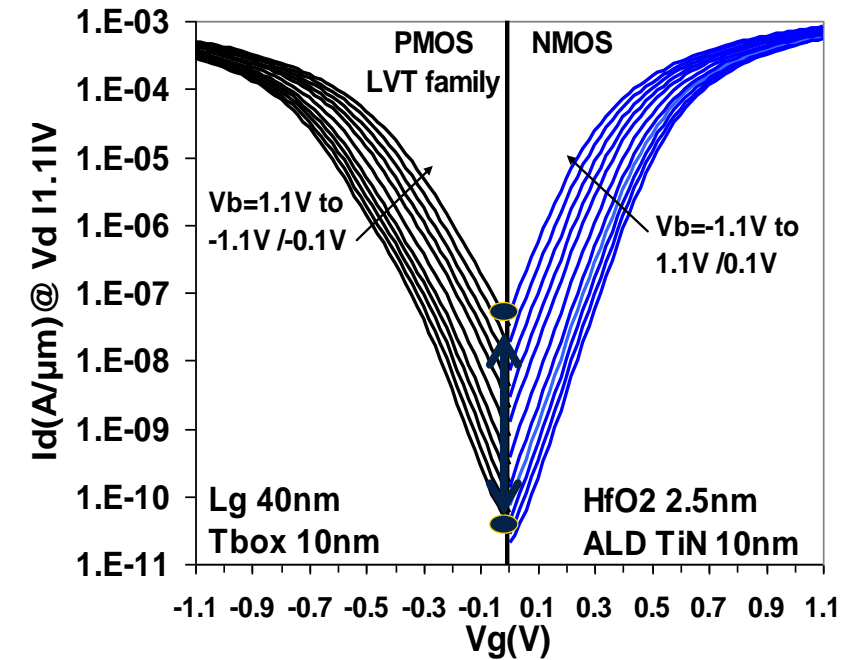


In ultra-low power IoT applications, we need to adopt a technology that is

- Ultralow leakage
- Ultralow power
- Ultralow voltage
- Cost effective!

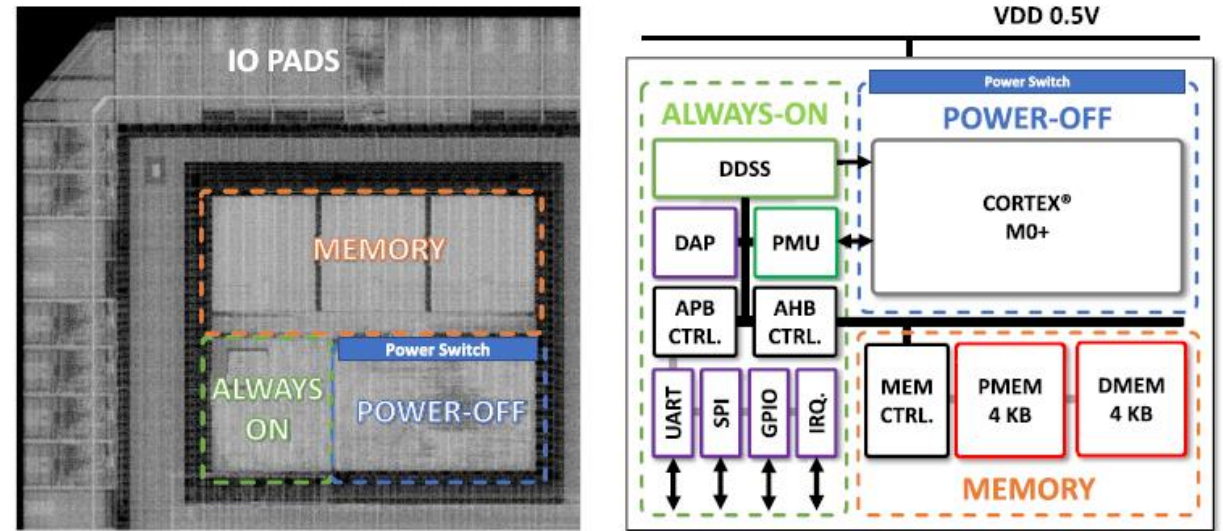


The presence of the buried oxide allows the application of back-biasing voltages, resulting in breakthrough **dynamic control of the transistor**

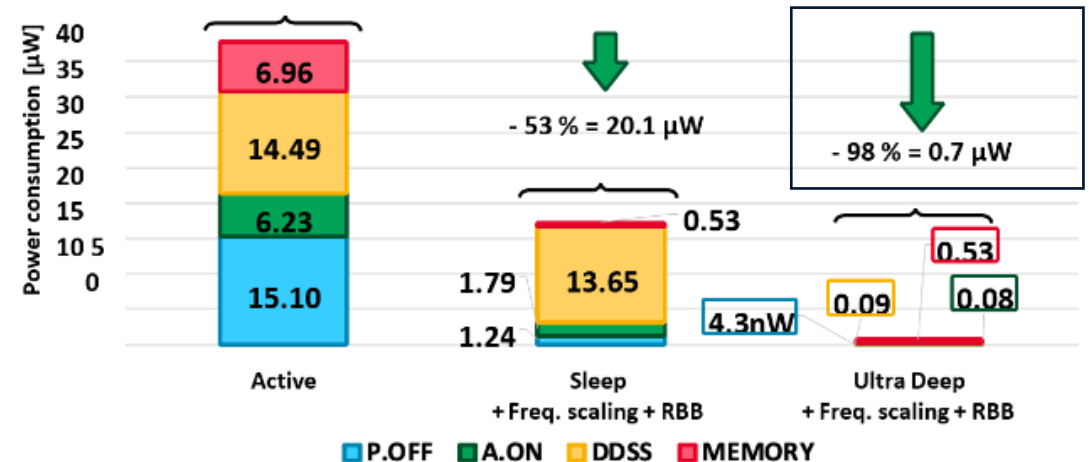


FDSOI for IoT: ultralow power FDSOI circuits

- FDSOI circuits in 28nm optimized for 0,5V operation
- **Back-bias technique is used to offer adaptive power reduction when the systems are asleep**
- 0,7 μ W deep sleep mode power consumption
- SoC compatible with energy harvesters that provide non continuous power

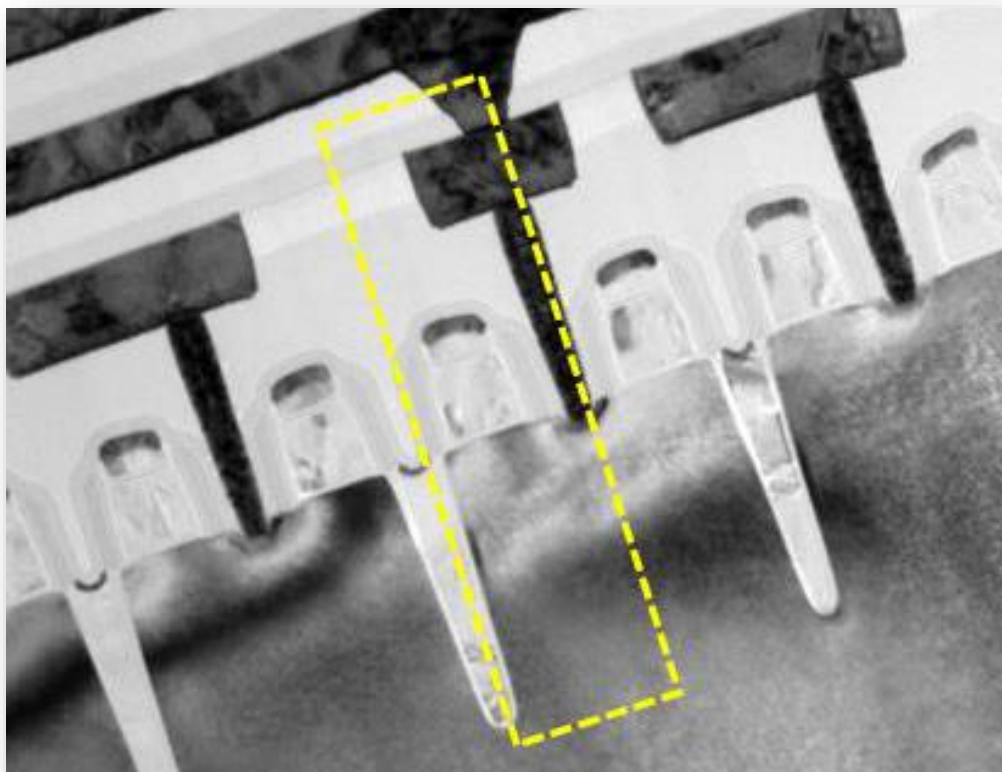


LALLEMENT *et al.*: 2.7 pJ/CYCLE 16 MHz, 0.7 μ W DEEP SLEEP POWER ARM CORTEX-M0+ CORE SoC IN 28 nm FD-SOI

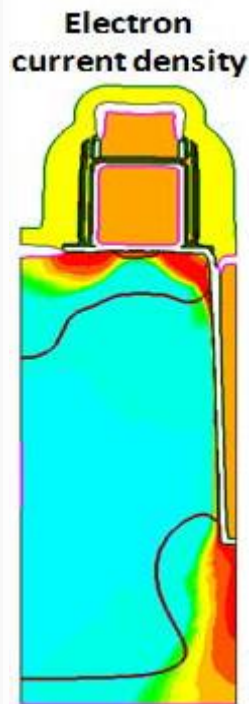


ULP microcontrollers with embedded Select in Trench Memory (eSTM)

- Very low Ioff & compacity control with vertical access MOS
- Production on 40nm node



S.Niel et al, IEDM 2018



Cell Architecture	1T eFlash Planar	1.5T eSTM Vertical
Device Schematic		
Technology node (Prod → R&D)	40nm	40 → 28nm
Memory layer	FG	FG
cell Area (40nm)	0.059μm ²	0.049μm ²
P/E Mechanism	CHEI / FN	SSI / FN
Prog. Time	~ μs	~ μs
Prog. Consumption	> 50μA	~ 1μA
Endurance	100K	100K-1M
Scalability	-	++

IOT: when mW can save kW

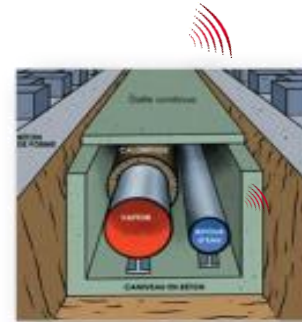
Home automation & malls

Detect any change in the environment: door & window opening, control of light & heat in rooms, movements, occupancy, customers traffic in malls...



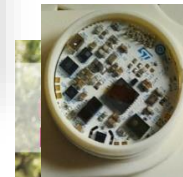
Monitoring and water saving

Heat distribution to detect pipes leaks, industrial monitoring to detect anomalous variations (temperature, vibrations, movement...), detection of leakage for water saving

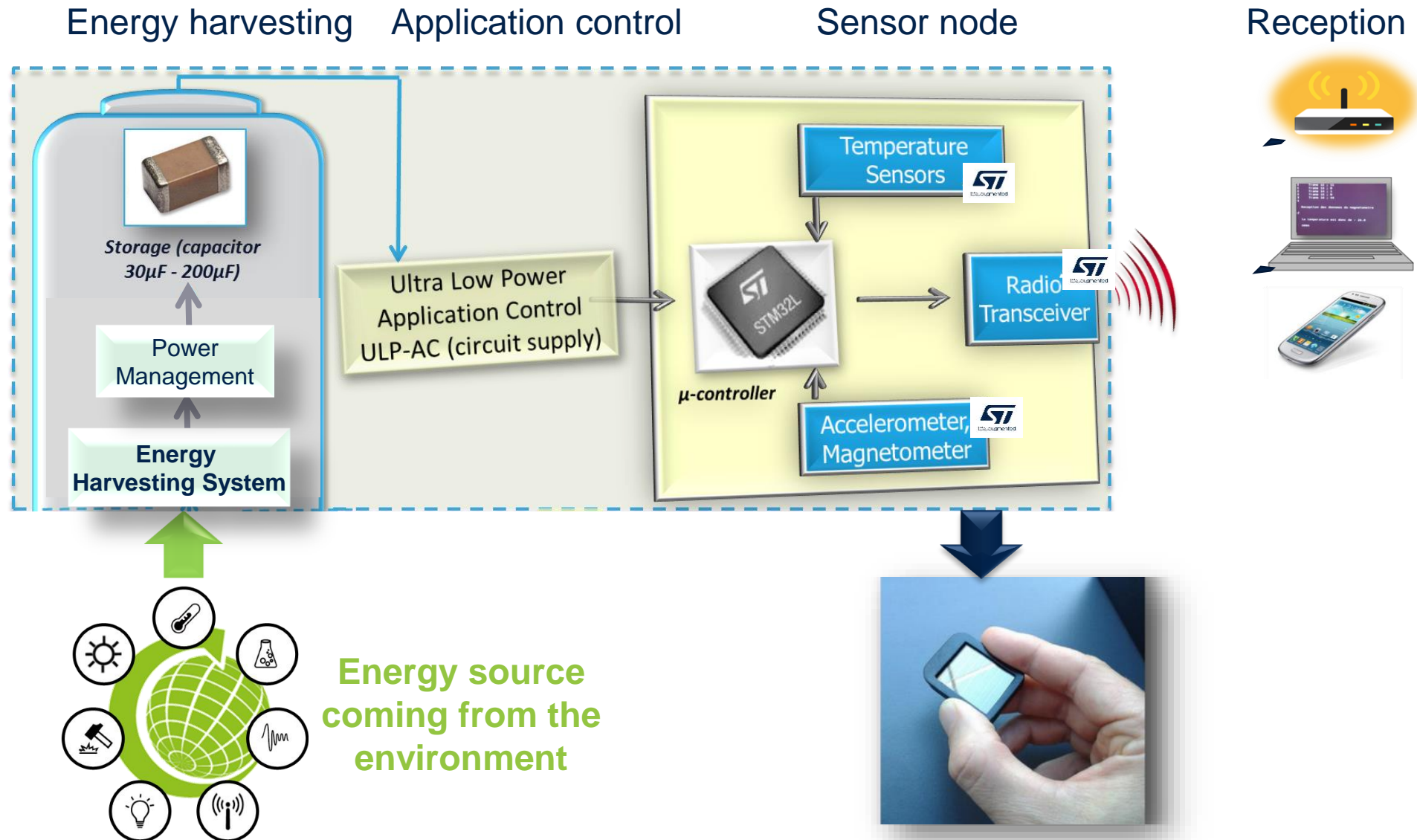


Logistics:

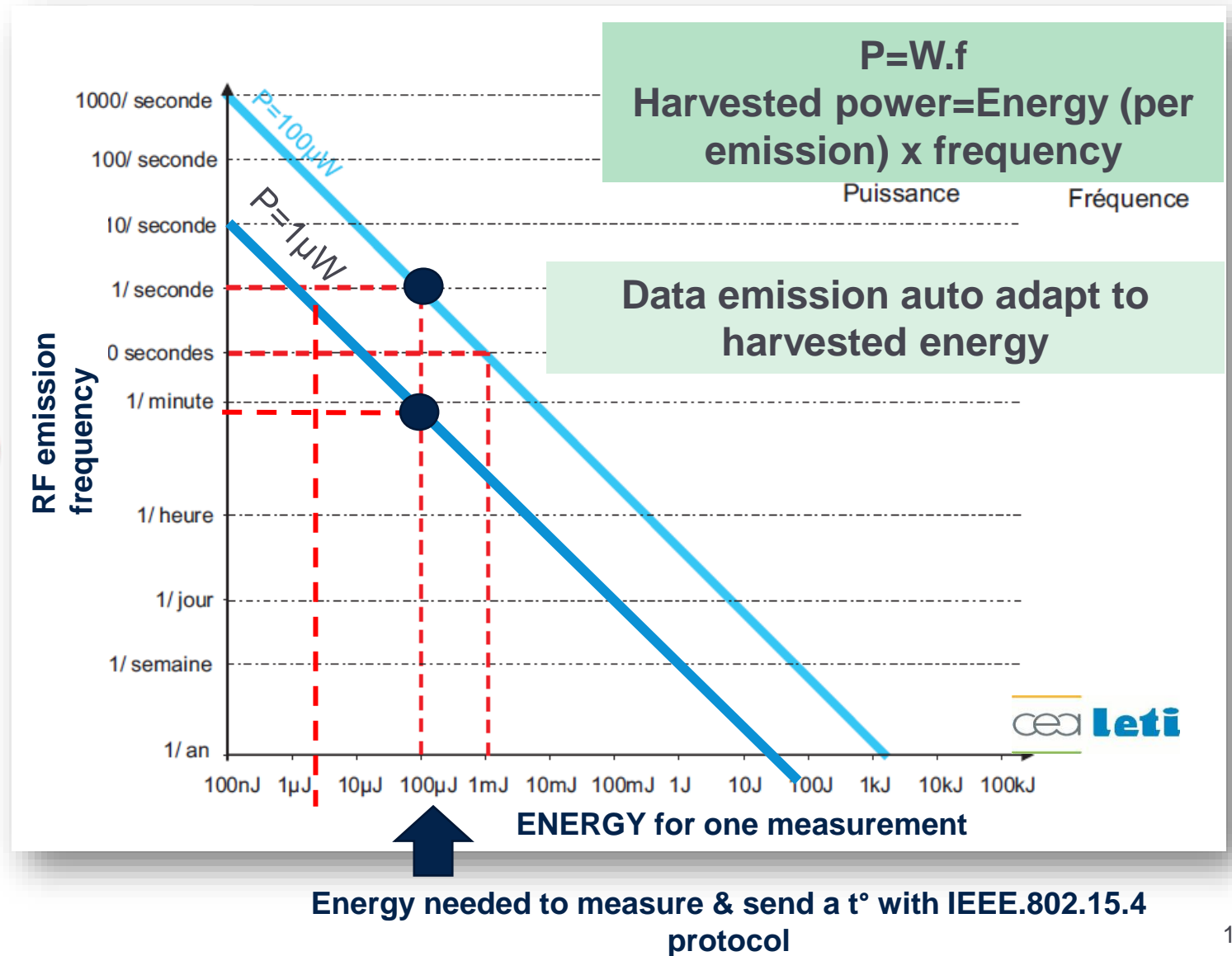
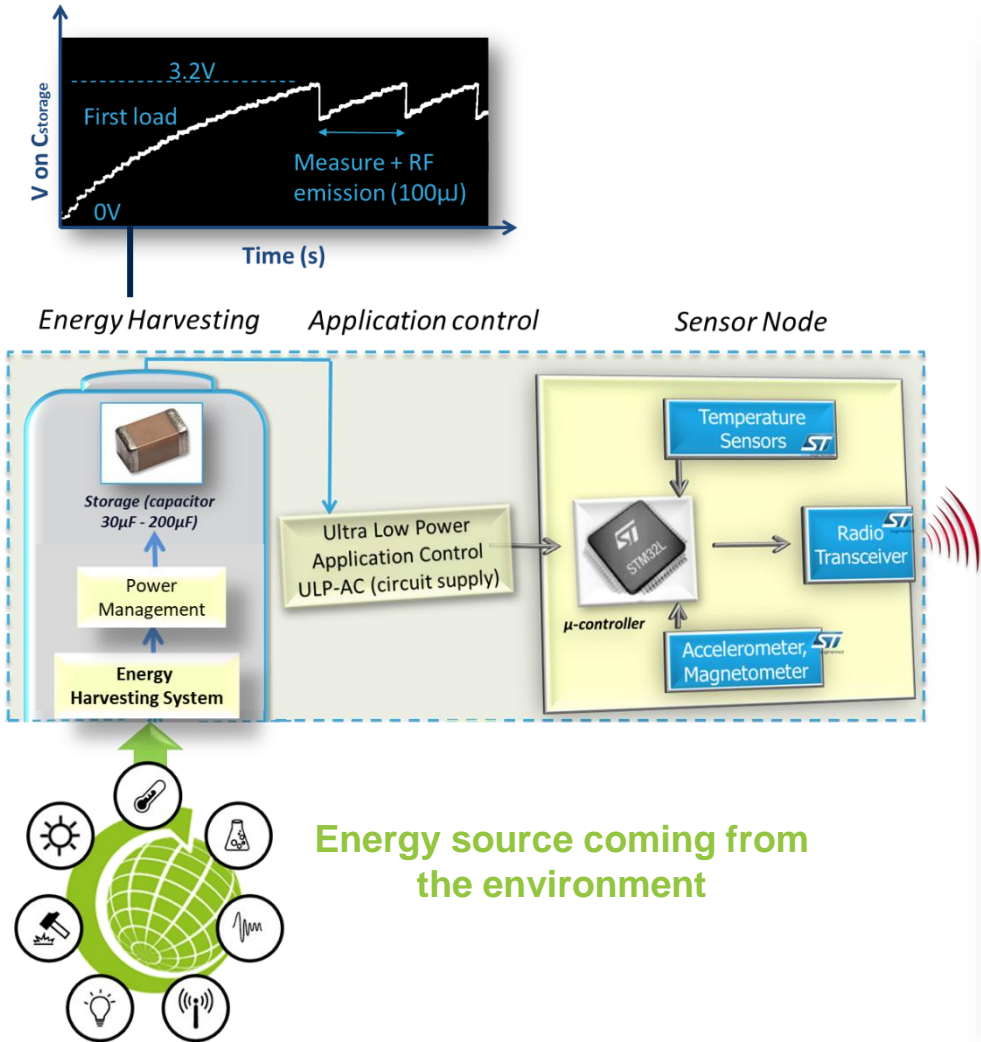
Containers & freight wagon Identification, green mobility identification...



Example of system for autonomous sensor node

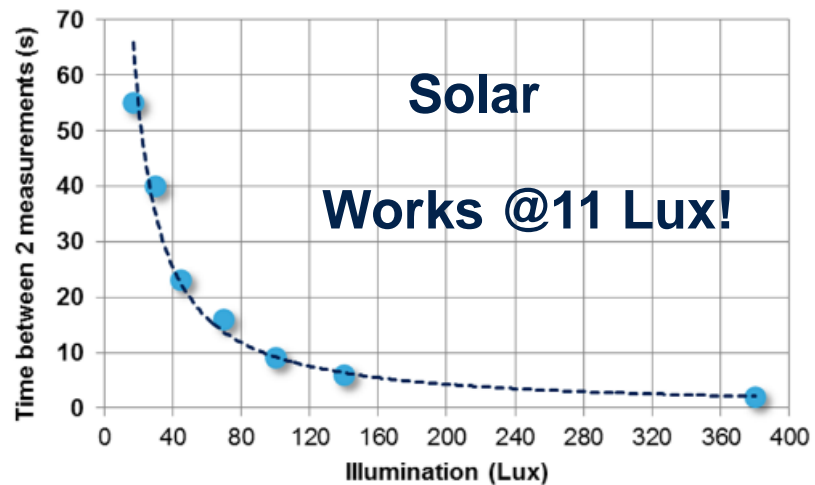
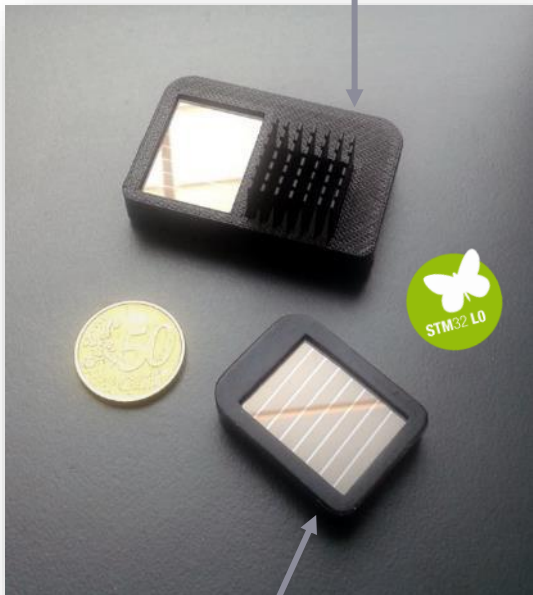


Key to work with very low energy= AUTO ADAPTATION



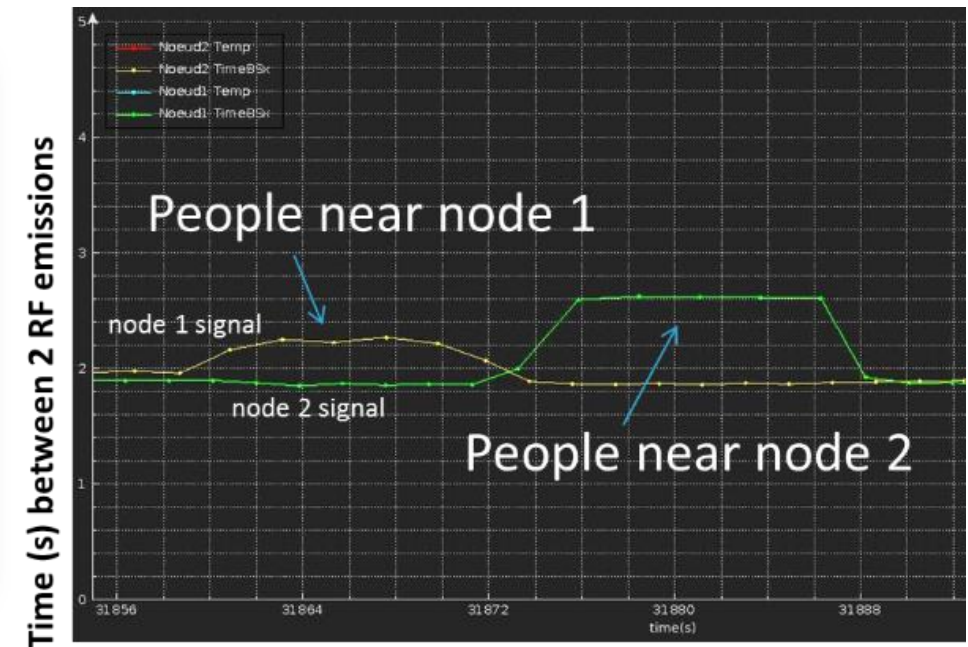
Harvested energy becomes the information

Sensor node powered by solar & thermal



Example with 2 solar nodes: movement is detected due to solar cell perturbation

Sensor node powered by solar



IoT for environmental sensors

Low power communicating sensors for water quality monitoring

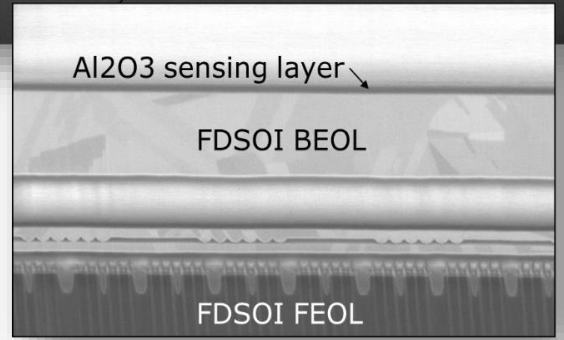
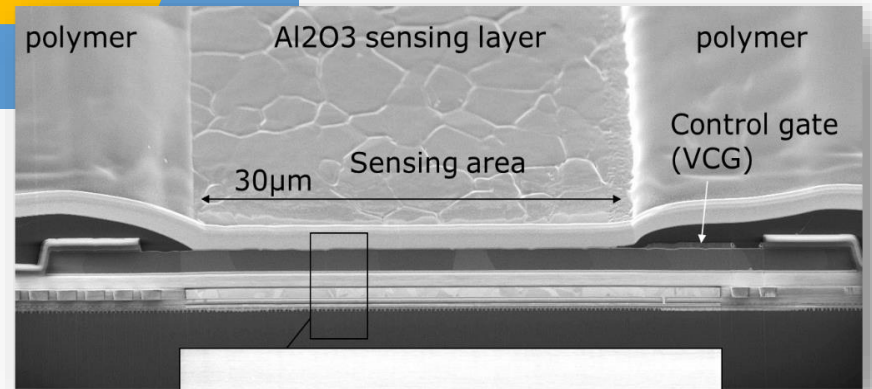
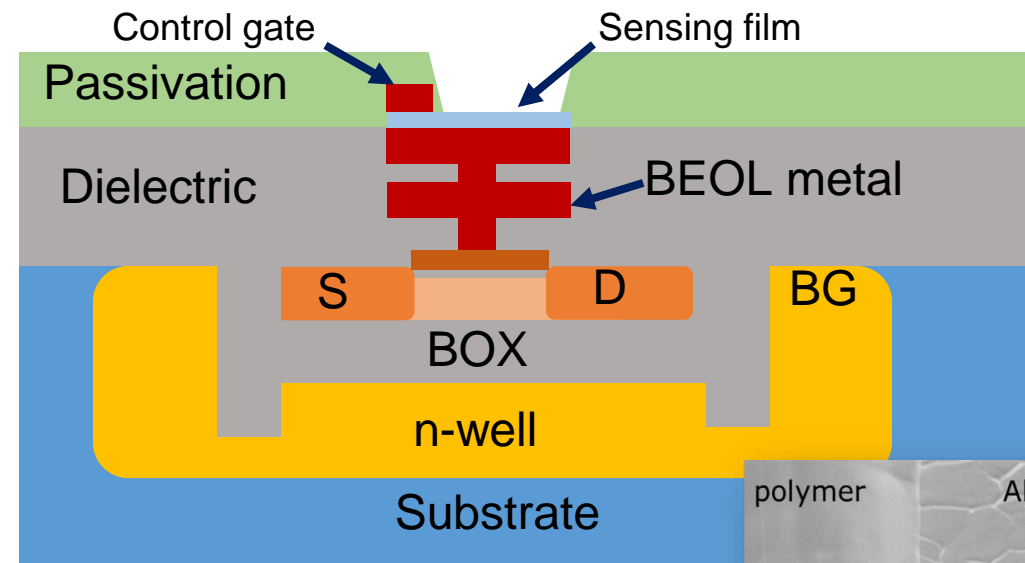
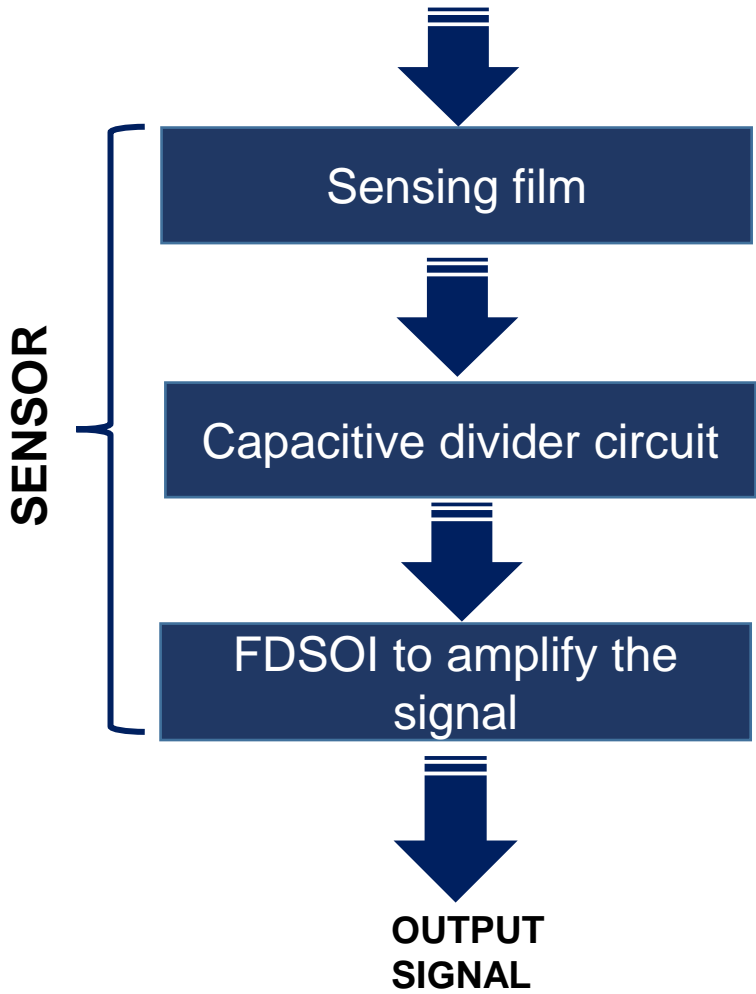


Low power communicating sensors for air quality sensing



Challenge: sensing technologies have to become low power

Integrated sensors on CMOS - FDSOI

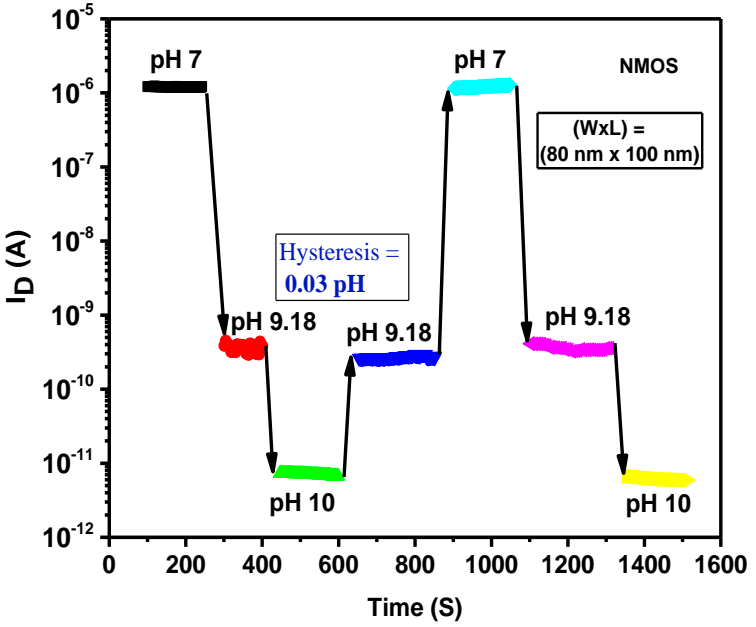


G.T. Ayele, VLSI 2018

Materials for environmental sensors



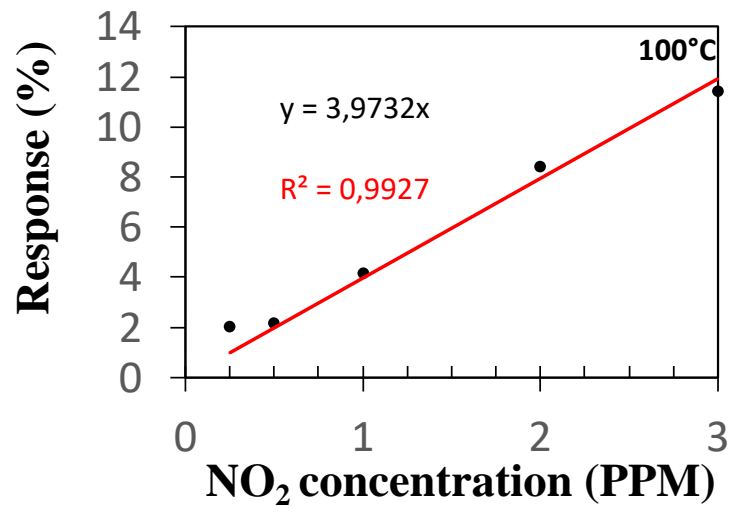
pH sensing with Al₂O₃ layer



G.T. Ayele, VLSI 2018

NO₂ sensing with SnO₂ layer

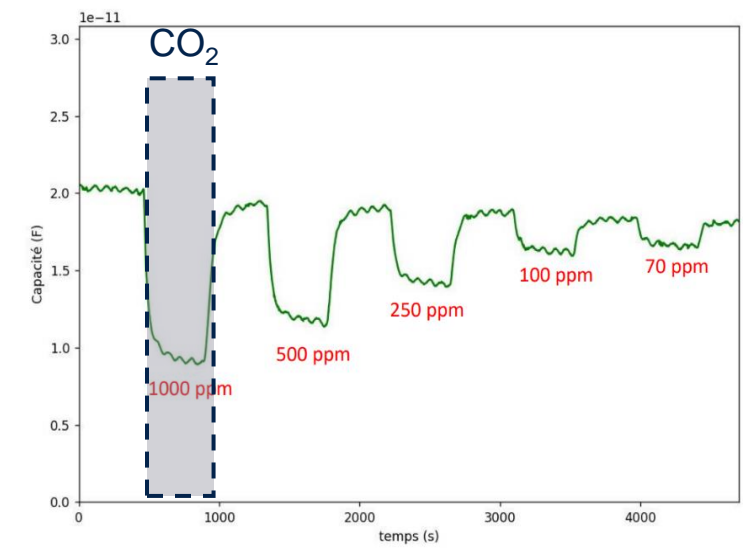
- Highest and fastest sensing response at 100°C
- Stable and reproducible response to NO₂



A. Assaf, A. Souifi – EMCM-DS 2022

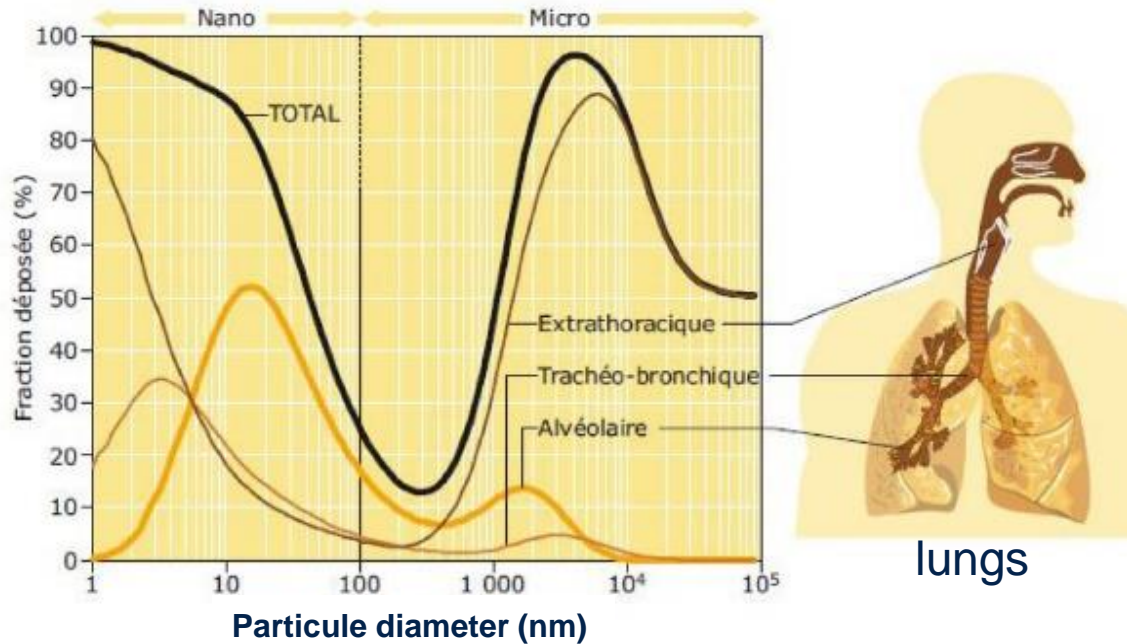
CO₂ sensing with hybrid polymers layer

Sensitivity measurement for different CO₂ concentrations for T=65°C, RH=45%



Photonics for environmental sensors

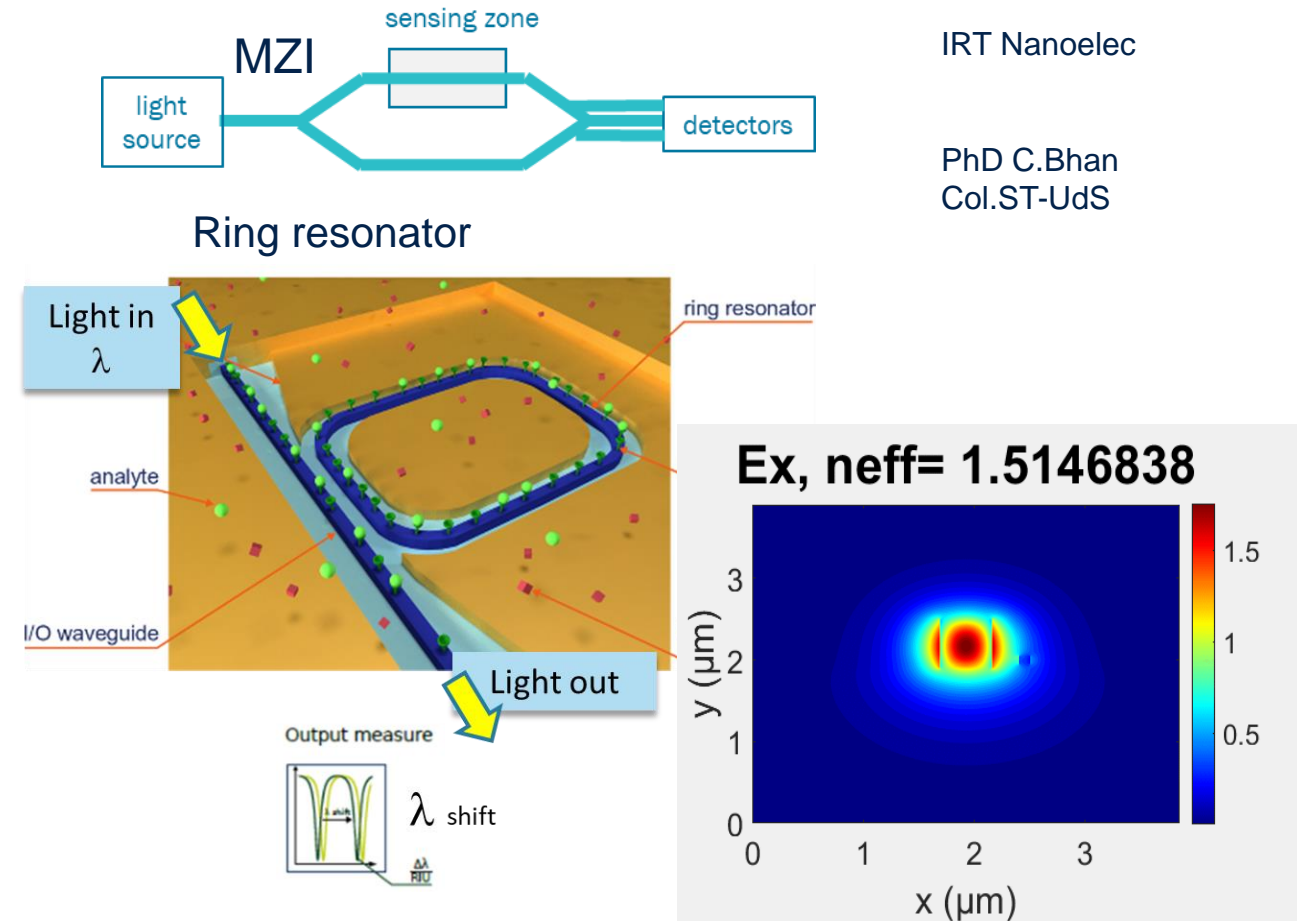
Nanoparticules sensing?



© Illustratek pour l'INRS

➔ Can detect sub-100nm particules

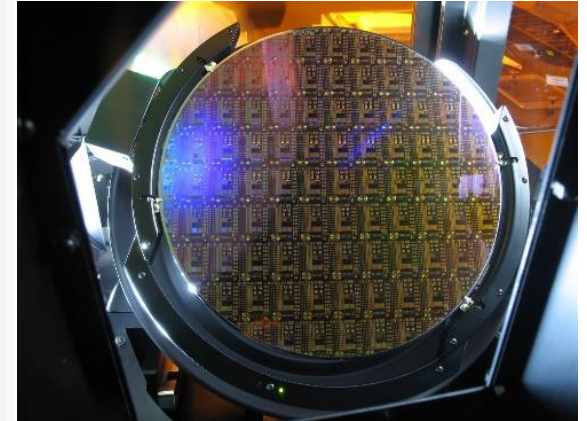
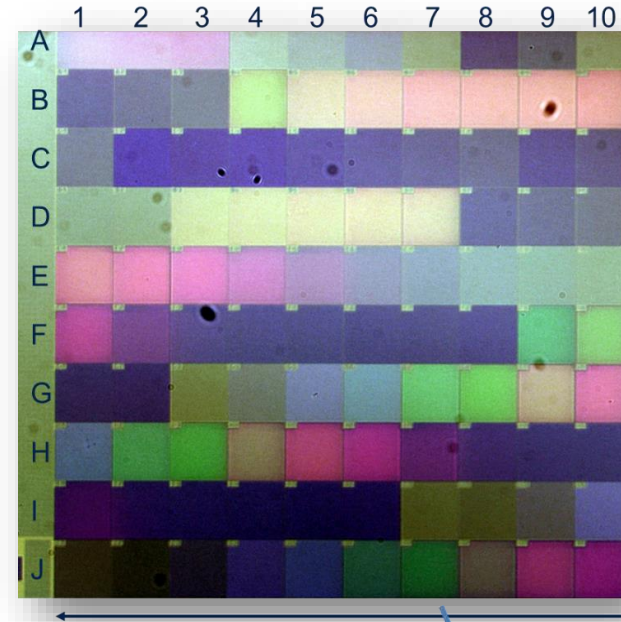
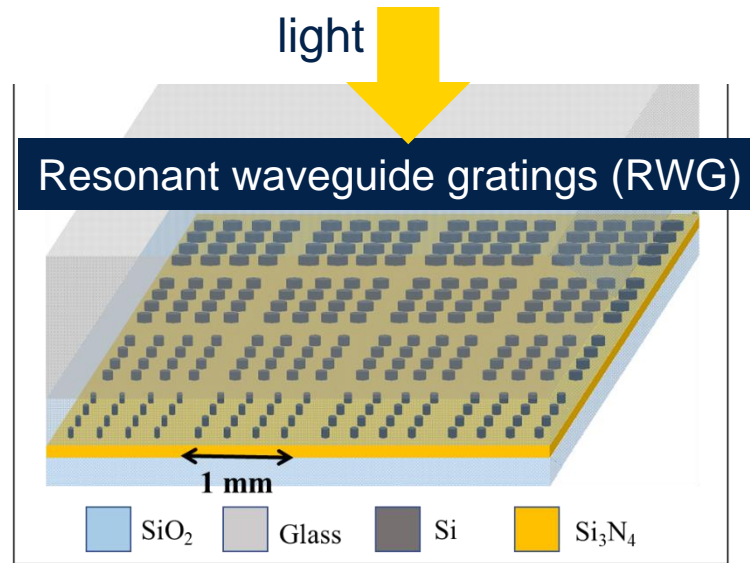
CO₂ sensing measurements



IRT Nanoelec

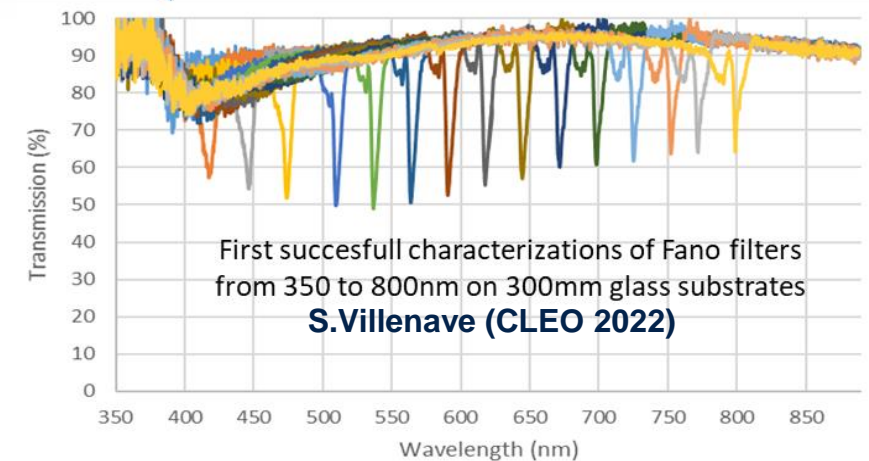
PhD C.Bhan
Col.ST-UdS

Optical filters on 300mm glass wafers



- Light incident on a periodic surface structure **excites a confined mode** in the layer
- **Sharp reflectance** peak (resonance for a given λ)
- Matrix of filters / **selection of wavelength with the matrix design** -> micro spectrometer

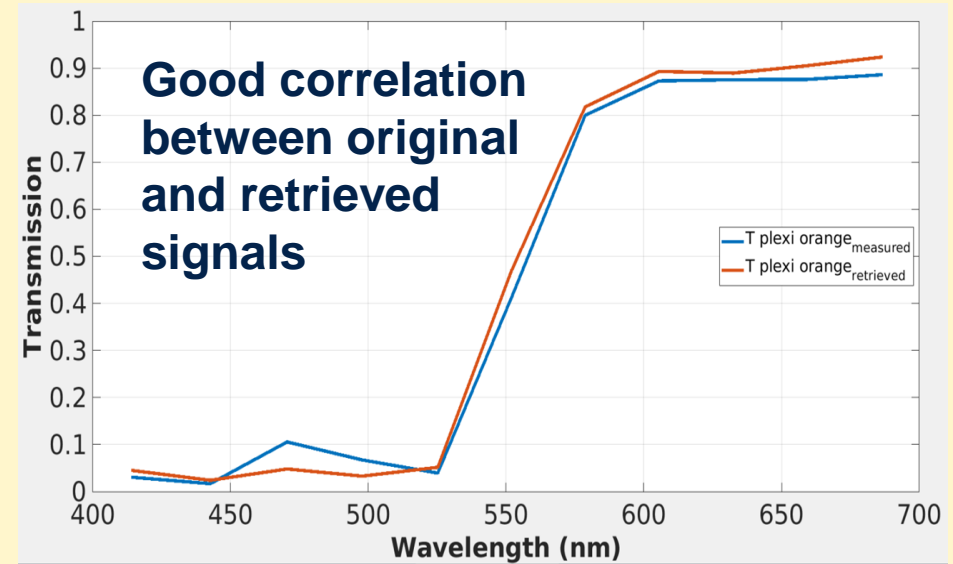
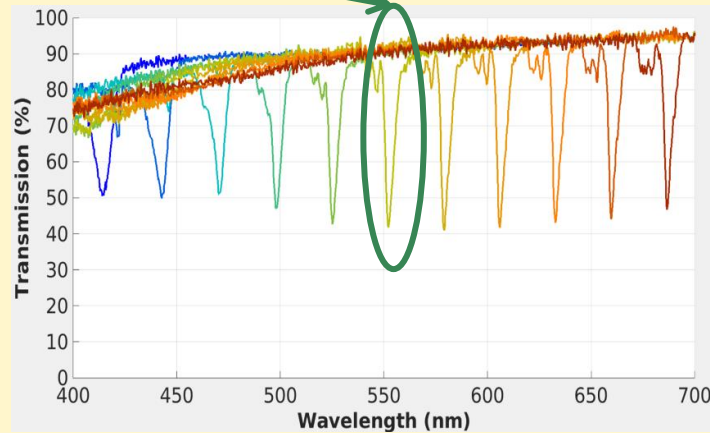
Application for environmental analysis



Environmental analysis with spectrum retrieval

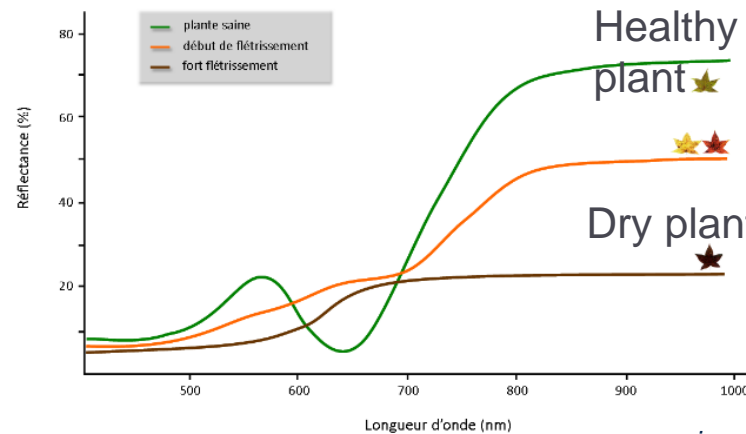


Example with 11 filters covering most of the spectral visible range



Retrieve the original spectrum of a sample thanks to a set of our filters

Example of application: chlorophyll spectrum retrieval and analysis of dryness

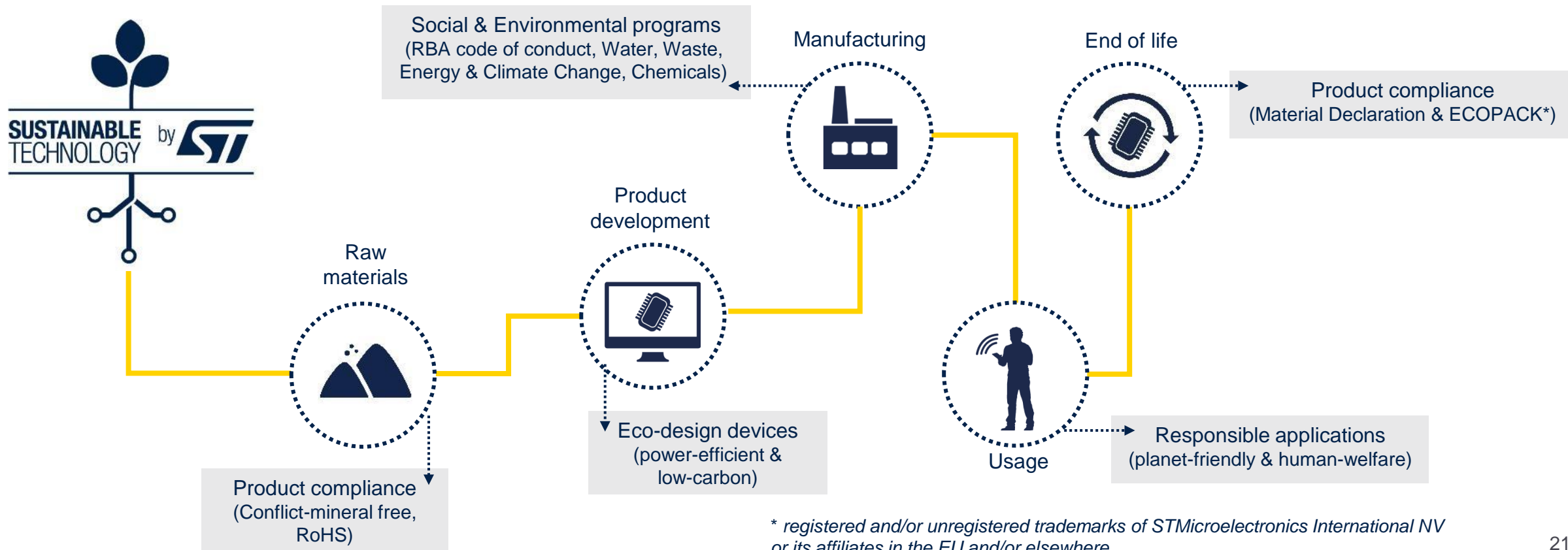


Agriculture, water saving...

Sustainable technology

Our Sustainable Technology program aims to develop responsible products which:

- Improve our social and environmental footprint at every stage of the product life
- Have the greatest positive impact on the planet and people in the end-application



** registered and/or unregistered trademarks of STMicroelectronics International NV or its affiliates in the EU and/or elsewhere*

ST will be carbon neutral for its 40th anniversary

Milestones

- Compliance with the 1.5°C scenario by 2025 – recognized by SBTi
- Carbon neutral by 2027
- Sourcing 100% renewable energy by 2027
- Collaborative programs and partnerships for carbon neutrality throughout our ecosystems



-40%
GHG emissions
scope 1 & 2 since
2018



Energy saving: example in eco conception


- Identification of most impacting recipes
- Develop « eco designed recipe » per level
- Verify impact on products
- Quantify environmental improvements

Numero	9	10	14	15	20	21	22
Description	TRANS T1	TRANS T2	TRANS T1	TRANS T2	STBL	EP STRIP	STRIP OE
Pression	5	5	7.5	7.5	10	10	10
Cl2	0	0	0	0	[Green shaded area]		
HBr	0	0	0	0			
CF4	0	0	0	0			
He	0	0	0	0			
O2	0	0	0	0			
CH2F2	0	0	0	0			
Temperature	[Blue shaded area]						
Step Type	Time	Time	Time	Time	Stab	EndPT	OverEtch
Duree	15	15	15	15	30	40	0
OverEtch (%)	0	0	0	0	0	0	50

Suppress gas during some temperature ramp or stabilization steps

Reduce overetch time

Conclusion

A hand holding a glass globe with a butterfly flying nearby in a grassy field.

Many technologies for diversification are in development in the semiconductor industry for responsible applications

A lot of efforts are made to contribute to a more sustainable industry

All are concerned, not only industry (Labs in France >15 000m² of clean room)

Our technology starts with You



Find out more at www.st.com

© STMicroelectronics - All rights reserved.

ST logo is a trademark or a registered trademark of STMicroelectronics International NV or its affiliates in the EU and/or other countries.

For additional information about ST trademarks, please refer to www.st.com/trademarks.

All other product or service names are the property of their respective owners.



life.augmented